

 $\frac{2}{2}$ $\frac{1}{2}$ $\frac{2}{2}$ $\frac{2}$





The Higgs discovery



ATLAS and CMS have established the existence of a Higgs-like particle at \sim 125 GeV





However



The effort of understanding this new particle have just started



The ILC Physics case

- The ILC Physics case comprises three flagships
- Higgs
 - Mass, Branching ratios, properties
- Top quark
 - Mass, cross-sections, decays, properties
- Search/study for new physics
 - Directly or indirect searches
 - Depends on what the LHC might find
- But there is more
 - Electroweak physics, flavor physics ...



The ILC program





- The Higgs mass of 125 GeV allows for a rich spectrum of Higgs decays
- Also ILC studies different production modes
 - Essential for measuring the total width (ILC-exclusive)







Higgs couplings

g(hAA)/g(hAA)|_{SM}-1 LHC/ILC1/ILC/ILCTeV



- At the End of the ILC program
 - Precise knowledge of all couplings (< 5%)
 - Will allow to disentangle if it is a SM Higgs or not

Si D •

Comparing with HL-LHC



SFitter Study

HL-LHC ~ 8% accuracy (gauge bosons) ILC ~ Order of magnitude better Take them with a grain of salt

- Everything based on
 - Studies, Extrapolations
 - Analyses in an early stage
 - Some "theoretical" assumptions
 - Personal views
- Clear ILC Advantages
 - Total Width measurement
 - H->cc measurement



Top Physics

- Top Threshold scans
 - $\Delta m_{top} < 40 \text{ MeV}$
- Conversion to MS scheme
 - Measured top mass at ILC can easily be converted to MS mass
 - This yields an total error of $\Delta m_{top} \sim 100$ MeV
 - Theory/ α_s limited
- Compared to LHC
 - Mass is Monte-Carlo Mass
 - Conversion is non-trivial



Electroweak Precision fits



Challenging the Standard Model with ultimate precision measurements





Physics case summary

The ILC machine offers unique advantages

- Clean environment
- Well defined initial states
- Possibility to do threshold scans
- Beam Polarization
- This allows
 - Precise studies of the Higgs & Top
 - Ultraprecise Electroweak precision studies
 - Search and Study for new physics



Just calles

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Ine Acceleration

The ILC machine



- Total length ~ 31 km
- Energy range

DESY

- Baseline Design 250-500 GeV
- Upgrade for 1 TeV



TDR Machine parameters

			Baselin	e 500 Ge	<u>Machine</u>	<u>1st Stage</u>	L Upgrade	E U	Ipgrade
Centre-of-mass energy	Есм	GeV	250	350	500	250	500	A 1000	B 1000
Collision rate	f_{rep}	Hz	5	5	5	5	5	4	4
Electron linac rate	f _{linac}	Hz	10	5	5	10	5	4	4
Number of bunches	nb		1312	1312	1312	1312	2625	2450	2450
Bunch population	Ν	×10 ¹⁰	2.0	2.0	2.0	2.0	2.0	1.74	1.74
Bunch separation	∆ <i>t</i> b	ns	554	554	554	554	366	366	366
Main linac average gradient	G _a	MV m ⁻¹	14.7	21.4	31.5	31.5	31.5	38.2	39.2
Estimated AC power	P _{AC}	MW	122	121	163	129	204	300	300
Electron polarisation	Р-	%	80	80	80	80	80	80	80
Positron polarisation	P+	%	30	30	30	30	30	20	20
IP RMS horizontal beam size	σ _x *	nm	729.0	683.5	474	729	474	481	335
IP RMS veritcal beam size	σ _y *	nm	7.7	5.9	5.9	7.7	5.9	2.8	2.7
Luminosity	L	×10 ³⁴ cm ⁻² s ⁻¹	0.8	1.0	1.8	0.8	3.6	3.6	4.9
Fraction of luminosity in top 1%	l0.01 /L		87.1%	77.4%	58.3%	87.1%	58.3%	59.2%	44.5%
Number of pairs per bunch crossing	N _{pairs}	×10 ³	62.4	93.6	139.0	62.4	139.0	200.5	382.6
Total pair energy per bunch crossing	E _{pairs}	TeV	46.5	115.0	344.1	46.5	344.1	1338.0	3441.0



Superconducting Cavities

2nd pass yield - established vendors, standard process



test date (#cavities)



- Tesla-Style Niobium Cavities for the Main Linac
 - Required Gradient 31.5 MV/m
- Production yield:
 - 94 % at > 28 MV/m,
 - Average gradient: 37.1 MV/m
 - Record 46 MV/m

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ILC Environment



- ILC environment is very different compared to LHC
 - Bunch spacing of ~ 554 ns (baseline)
 - 1312 bunches in 1ms
 - 199 ms quiet time
- Occupancy dominated by beam background & noise
 - ~ 1 hadronic Z per train ...
- Readout during quiet time possible
- No Triggers, no pile-up ...



The Interaction region



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ILC costs & readiness



- Construction
 - 10 years till physics
- ILC project costs (2012)
 - ~ 8 billion USD for 500 GeV machine
 - ~70 % in the main linac







Detector Requirements

m Exceptional precision& time stamping ar У V - Single Bunch resolution IL er С ti Vertex detector С z e - < 4 µm precision ΗV - $\sigma_{r\phi} \approx 5 \ \mu m \oplus 10 \ \mu m / p \sin^{(\frac{3}{2})}(\theta)$ in tt → µ ÷ e Tracker μ-V e $-\sigma(1/p) \sim 2.5 \times 10^{-5}$ nt a S n yt Calorimeter W hi -Z $-\frac{\sigma_{E_{Jet}}}{E_{Jet}} = 3 - 4\%, E_{Jet} > 100 GeV$ n S g e p ar at io



Marcel Stanitzki

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Different challenges

- Calorimeter granularity
 - Need factor ~200 better than LHC
- Pixel size
 - Need factor ~20 smaller than LHC
- Material budget, central tracking
 - Need factor ~ 10 less than LHC
- Material budget, forward tracking
 - Need factor \sim >100 less than LHC

Requirements for Timing, Data rate and Radiation hardness are very modest compared to LHC





SiD Detector overview

SID Rationale

- A compact, cost-constrained detector designed to make precision measurements and be sensitive to a wide range of new phenomena
- Design choices
 - Compact design with 5 T field.
 - Robust silicon vertexing and tracking system with excellent momentum resolution
 - Time-stamping for single bunch crossings.
 - Highly granular Calorimetry optimized for Particle Flow
 - Iron flux return/muon identifier is part of the SiD selfshielding
 - Detector is designed for rapid push-pull operation





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Many reports

SLAC-PUB-11413

The SILICON DETECTOR (SiD) and LINEAR COLLIDER DETECTOR R&D in ASIA and NORTH AMERICA*

James E. Brau, University of Oregon, USA Martin Breidenbach, SLAC, USA Yoshiaki Fujii, KEK, Japan Hermeticity (both crack-less and coverage to very for ward angles) to precisely determine the missing mo mentum.

Abstract In Asia and North America research and development In Asia and North America research and development on a linear collider detector has followed complementary paths to that in Europe. Among the developments in the US has been the concerption of a detector built around alii-con tracking, which relies beavily on a pixel (CCD) vertex detector, and employs a silicon turgaryloy as alikon turgaryloy as like detector, built different from the TESLA detector, we this detector is quite different from the TESLA detector, we provide a strategies and the sub-system specific describe there, along with some of the sub-system specific

Figure 1: The Silicon Detector The strategy of energy-flow calorimetry leads directly to

of BR2 to provide charged-neutra

a jet, and to an electromagnetic calorime design with a small Moliere radius and smal Additionally, it is desirable to read out each

ment. This leads to the same nominal s

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both TESLA and the Silicon Detector use sili-con/ungsten for the EM calorimeter.

The Large Detector and the JLC Detector choose scin-tillator tile with lead for EM and hadron calorimetry.

Other details vary, including the choice of magnetic field, which ranges from 3 up to 5 Tesla. Each of these designs is guided by the physics goals, which lead to the following principal detector goals:

Two-jet mass resolution, comparable to the natural widths of the W and Z for an unambiguous identifi-caion of the final states.

· Excellent flavor-tagging efficiency and purity.

Momentum resolution capable of reconstructing the recoil-mass to di-muons in Higgs-strahlung with res-olution better than the beam-energy spread.

pixel size. Additionally, laver of the EMCal to p e authors acknowledge the help of the following people in prepar-soverview: Gene Fisk, Ray Frey, John Jaros, Torn Markiewicz, Ichurans, Eric Torrerce, and Jac Yu. e anner JLC was changed to GLC in April, 2003. shower de lution as TESLA: a series of layers of about $0.5 X_0$ Tung-sten sheets alternating with arrays of silicon diodes. Such

Presented at 4th ECFA / DESY Workshop on Physics and Detectors for a 90-GeV to 800-GeV Linear e-Amsterdam, The Netherlands, 1-4 Apr 2003. Work supported in part by Department of Energy contract DE-AC02-76SF00515 s for a 90-GeV to 800-GeV Linear e+ e- Collide











SiD Letter of Intent



AND DETECTORS AT CLIC CONCEPTUAL DESIGN REPORT

GENEVA 2012

2011 STATUS REPORT















SiD & the DBD

- The DBD describes a baseline of SiD for the ILC
 - Choices have been made for all subsystems besides the Vertex detector
 - Options for various subsystems have been considered
 - The detector is fully costed
- The DBD is not a TDR
 - Engineering effort not sufficient
 - Not all R&D has been completed
- In SiD's view the subsystem options offer
 - Improved performance or lower cost
 - Not as mature as the baseline choices yet





The DBD detector



- SiD is fully designed for push-pull (using a platform)
- PFA paradigm has driven design choices



DBD Detector parameters

SiD BARREL	Technology	Inner radius	Outer radius	z max
Vertex detector	Silicon pixels	1.4	6.0	± 6.25
Tracker	Silicon strips	21.7	122.1	\pm 152.2
ECAL	Silicon pixels-W	126.5	140.9	\pm 176.5
HCAL	RPC-steel	141.7	249.3	\pm 301.8
Solenoid	5 Tesla	259.1	339.2	\pm 298.3
Flux return	Scintillator/steel	340.2	604.2	\pm 303.3
SiD ENDCAP	Technology	Inner z	Outer z	Outer radius
Vertex detector	Silicon pixels	7.3	83.4	16.6
Tracker	Silicon strips	77.0	164.3	125.5
ECAL	Silicon pixel-W	165.7	180.0	125.0
HCAL	RPC-steel	180.5	302.8	140.2
Flux return	Scintillator/steel	303.3	567.3	604.2
LumiCal	Silicon-W	155.7	170.0	20.0
BeamCal	Semiconductor-W	277.5	300.7	13.5



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Vertex Detector

- Many potential technology choices
 - No baseline selected yet
 - Technology not there yet
- Requirements
 - <5 μ m hit resolution
 - $\sim 0.1 \% X_0$ per layer
 - < 130 µW/mm²
 - Single bunch timing resolution
- Insertion of Vertex straightforward
 - Allows to make late technology choice







- 5 Barrel Layers, 4 Disks, 3 Forward Disks
- Total power consumption ~ 20 W
- Air-cooled
- Powering using DC-DC or serial powering



- Learn from LHC upgrade experiences



Vertex Technology

- Vertex Pixel has unique requirements
 - Small pitch
 - Single-bunch timestamping
 - Low power consumption
- In-pixel intelligence
 - Zero suppression
 - ADC
 - Trim & Mask
 - Storage

- MAPS technology can fulfill these requirements
 - It's not there yet, but ...
 - The way ahead is clear
- RAL MAPS programme
 - Has key building blocks
 - Large sensors
 - In-pixel intelligence
 - In-pixel Storage
- Still leading player
 - Although other have caught up





Silicon Strip Tracker

All silicon tracker

- Using silicon micro-strips
- Double metal layers
- 5 barrel layers and 4 disks
- Cooling
 - Gas-cooled
- Material budget
 - less than 20 % X_0 in the active area
- Readout using KPiX ASIC



 Bump-bonded directly to the modules





Tracker Module





Track module

- 25/50 µm strip pitch
- Double metal layers
- Two KPiX per sensor
- Hybrid-less design







Silicon Strip Tracker

All silicon tracker

- Using silicon micro-strips
- Double metal layers
- 5 barrel layers and 4 disks
- Cooling
 - Gas-cooled
- Material budget
 - less than 20 % X_0 in the active area
- Readout using KPiX ASIC



 Bump-bonded directly to the modules



SiD Tracking System



Track seeding and fitting uses entire tracking system

- 7 hits required (6 in second pass)
- Calorimeter seeding (V₀ finder)


Tracking Performance

- SiD tracking is integrated
 - Vertex and Tracker
 - 10 Hits/track coverage for almost entire polar angle
- Tracking system
 - Achieves desired $\Delta p_T/p_T$ resolution of 1.46 $\cdot 10^{-5}$
 - >99 % efficiency over most of the phase space
 - Impact parameter resolution of ~ 2 µm demonstrated





Robustness vs. backgrounds



- Z' → uds at 1 TeV with one bunch crossing of background overlaid
- Demonstrates robustness of SiD Tracking





Calorimetry

- SID ECAL
 - Tungsten absorber
 - 20+10 layers
 - $20 \times 0.64 + 10 \times 1.30 X_0$
- Baseline Readout using
 - 5x5 mm² silicon pads

- SID HCAL
 - Steel Absorber
 - 40 layers
 - 4.5 Λ_i
- Baseline readout
 - 1x1 cm² RPCs
- SiD has selected baseline choices for its Calorimeter
 - Options are being considered
- Lots of test beam activities (past, present and future)
 - Parts of the program done as part of the CALICE effort









The SiW ECAL

- One ECAL Si sensor
 - 1024 hexagonal pixel
 - Readout by 1 KPiX
- KPiX and cable bumpbonded to the sensor
- Analog Readout
 - Deposited charge
- Aim: minimize gap size
- Tungsten plates used as heatsink











Digital ECAL option

- DECAL = Shower particle counter
 - $N_{particles} \sim Energy$
 - Eliminating landau tails
 - Ultimate granularity
- Using pixel sensors for the readout
 - UK Idea
 - TPAC MAPS designed at RAL
 - Successful Testbeams at DESY, CERN
- Since UK pulled out



- Project Stalled









HCAL Baseline

Digital HCAL

- Counting shower particles
- N_{particles} ~ Energy
- Using Glass RPCs
 - 1 x 1 cm²
- 1 m³ prototype built
 - 500.000 channels
 - Largest Calorimeter by channel so far





RPC DHCAL



- After an extensive Test beam campaign
 - The RPC technology is a great candidate for the readout of a highly segmented calorimeter.
 - The dark rate in the DHCAL is very low
 - The response is linear up to about 30 GeV/c.





Muons

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- Major change in baseline option
 - Readout technology
- New baseline option
 - Scintillator bars
 - SiPM readout
 - First engineering desing of the muon layers
- RPC remains an option
 - Still actively being pursued





Forward Systems



- SiD has two detectors in its forward region
 - LumiCal and BeamCal
 - SiD R&D is part of the worldwide FCAL effort.
 - Close interactions with MDI group
- A dedicated chip for BeamCal (Bean) has been developed











- The 5 T coil builds on the CMS experience
 - Especially on the CMS Conductor
- Engineering challenges are well understood
 - Advances in computing ease the design







Push-Pull Concept



- Push-Pull using concrete platform
- SiD is optimistic to do Push-pull in a few days
- DESY
- Minimum estimate is 32 hours



SiD Assembly

Assembly beam

Assembly Spider

Insertion beam

Truck with HCAL Module









- SiD assumes common unit costs
 - As agreed by all groups
- Assuming "almost everything beyond the platform" is machine cost
- Follows machine costing model
- Costs in 2008 US-S
 - M&S : 315 M\$
 - Contingency: 127 M\$
 - Effort: 748 MY









Costing M&S

SiD M&S







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Cost Dependence



 Parametric Detector costing model allows study of main parameter dependencies

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- Shown is Base M&S cost
 - Labor and Contingency excluded





Cost Sensitivity

- How the magnet is costed
 - SiD assumes magnet made by industry (risk is with vendor)
 - Change to CMS-style model (Collaboration takes risk)
- Cost Sensitivity analysis (double unit costs)
 - Silicon sensors and magnet have largest impact
 - 26 and 14 % cost increase respectively
- "Optimizing costs"
 - Half the price of silicon, CMS-style magnet pricing, reducing RPC costs
 - Total SiD cost changes from 315 to 222 M\$





Si D · Simulation & Reconstruction

- Full Simulation& Reco
 - Including beam backgrounds
- Simulation
 - Detailed GEANT4 detector simulation
 - Including "dead areas"
- Reconstruction
 - Digitization, Tracking, Particle
 Flow, Flavor Tagging
 - No cheating at all











Simulating backgrounds

- Pair background
 - ~ 400k/ BX @ 1 TeV
 - Very forward
- $\gamma\gamma \rightarrow$ hadrons
 - 4.1 events per BX @ 1 TeV
 - 1.7 events per BX at 500 GeV
 - More central
- Overlays these over "physics events"







• Si D •

Simulated pairs



- Backgrounds with the current design
 - Improvements possible (Final Focus optimizations)



PFA in a nutshell





Jet Resolutions

Particle Class	SubDetector	Jet energy fraction	Particle Resolution	Jet Energy Resolution
Charged	Tracking	60%	$10^{-4} \sqrt{E_{charged}}$	neg.
Photons	ECAL	30%	11 % √E _{EM}	6 % √E _{iet}
Neutral Hadror	HCAL (+ECAL	10%	40 % $\sqrt{E_{hadronic}}$	13 % √E _{jet}

- Energy resolution about 14% (driven by HCAL)
- Confusion terms have bigger impact

 $-\sigma_{jet}^{2} = \sigma_{charged}^{2} + \sigma_{EM}^{2} + \sigma_{hadronic}^{2} + \sigma_{confusion}^{2} + \sigma_{threshold}^{2}$

- Performance not limited by Calorimetry
 - Need high granularity calorimetry to reduce confusion !
- Current best PFA ~25 % / \sqrt{E} for 100 GeV Jets

Performance: Vertexing



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- SiD vertex detector design allows
 - High resolution vertexing
 - Robustness against backgrounds
 - b and c-tagging



- Using LCFIplus package

Performance: PFA



- SiD PFA performance is excellent
 - Fulfills ILC physics goals
- Robust against backgrounds



 Driven by all-Silicon approach and single-bunch timestamping



Benchmarking SiD

• As part of the validation process, SiD was asked

- to perform "physics benchmarks" to illustrate "readiness for ILC physics"
- Two sets of benchmarks for both Letter of Intent and DBD
- Done with full simulation and reconstruction
- $\sqrt{s} = 250 \text{ GeV}$
 - Higgs BR and recoil
- $\sqrt{s} = 500 \text{ GeV}$
 - tt cross section
 - ττ polarization
 - Gaugino pairs

• $\sqrt{s} = 500 \text{ GeV}$

- tt cross section
- $\sqrt{s} = 1 \text{ TeV}$
 - vvH Higgs BR
 - tīH
 - WW DBD



Lol



DBD event production

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- 50.7 million events at 1 TeV
 - 4.7 million $\gamma\gamma \rightarrow$ hadrons
- 6.55 million events at 500 GeV
 - 4.4 million $\gamma\gamma \rightarrow$ hadrons
- In Total
 - 180 TB data
 - 211 CPU years

Country	Total CPU Time (years)		
UK	100.2		
СН	68.2		
FR	15.0		
US	28.2		
TOTAL	211.6		
PAR-XX5-B	Marce! Stanitz		



Higgs Recoil Benchmark



- Measuring σ_{zH} , m_{H} at $\sqrt{s} = 250$ GeV
 - Δm_{H} =40 MeV, $\Delta \sigma_{ZH}$ =2.7%
 - Decay-mode independent
 - Constraining "invisible" decay modes





SiD

tt production



• Measuring σ_{tt} at $\sqrt{s} = 500 \text{ GeV}$

- Test of SM
- Handling six jet final states
- Benchmark is using both beam polarization states
- $\Delta \sigma_{tt} = 0.47/0.69 \%$



Top-Yukawa Coupling



• Measuring Y_{top} at $\sqrt{s} = 1$ TeV

- Using six and eight jet final states with 4 b jets
- Stressing PFA and b-tagging
- Combined measurement: $\Delta Y_{top} 4.5 \%$



$H \rightarrow \mu \mu$ Branching ration



- Measuring BR H $\rightarrow \mu^+\mu^-$ at $\sqrt{s} = 1$ TeV
 - Challenging channel
 - Relies on excellent tracking
 - Accuracy achieved : ΔBR=32%







TDR completed !

- Mandate of the Global Design Effort for the ILC (2005-2012)
 - Deliver a TDR document by the end of 2012
- Goal has been achieved
- TDR with 5 volumes
 - Exec Summary, Physics, Accelerator, Detectors, Outreach
- TDR was funding/effort limited
 - Not everything we had planned is in
- Detector went from TDR to DBD
 - Detailed Baseline Design
- Physics case summarized in one volume



Si D · Final TDR Review Outcome

"As compared to other projects of similar scale (ITER, LHC, ATLAS, CMS, ALMA, XFEL, FAIR, ESS, SSC) the quality of the documentation presented by the GDE team is equal or superior to that utilized to launch into a similar process."

The ILC is good to go!









TDR/DBD Signatories

- A Call for signatories has been made, inviting
 - Everyone who was contributed
 - Everyone interested or supporting the case for the ILC
- Overall signatories
 - 48 countries
 - 392 Institutes
 - 2400 signatories
- Largest
 - Signatories per Country : Japan (506)
 - Institutes per Country : USA (75)
 - Institute worldwide: DESY (HH+ZN), KEK: 185/184
 - Region: Europe (1185)





The ILC world




The LCC organization

- Mandate of GDE is complete
- ICFA has created the "Linear Collider Collaboration"
- Three pillars
 - ILC
 - CLIC
 - LC detectors and physics
- LCC is lead by Lyn Evans









Developments in Japan



- LCC director has meet with PM Abe in March
- More than 150 japanese MPs lobby for the ILC
- High-ranking Japanese delegations visits Washington
 - ILC is major agenda item



Japan plans to select a potential host site by the end of this summer Marcel Stanitzki



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Upcoming ILC events

• June 12th, 2013

- Official hand-over of the TDR in all three regions
- Events at Tokyo, CERN, FNAL
- November 11th -15th 2013
 - International Linear
 Collider Workshop in
 Tokyo









How can I get involved ?

The finalization of the DBD is a great opportunity

- To refine the current design
- To test new ideas
- There are still many things to do to make SiD a reality

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- Please get in touch with the SiD spokes Andy White (UTA) and myself
- We'll point you to the right contacts in SiD
- Participate in the workshops
 - Best opportunity to know what is going on
- Also software studies are very welcome
 - Easy way to start contributing to SiD







- ILC physics case has been made
- ILC machine status
 - TDR finalized, technology is ready
- SiD
 - A compact high-field all silicon detector
 - Demonstrated readiness for ILC physics
- Japan
 - Developments there are very encouraging
- ILC is prominently mentioned in the Japanese and European strategy



- Hoping for similar support from US Snowmass process









KPiX- System on a chip

KPiX

- Aimed at ILC
- 1024 channel, 4 buffers/channel

Key Feature

- Low noise dual range charge amplifier w 17 bit dynamic range.
- Power modulation average power <20 µW/channel
- Noise Floor: 0.15 fC









The Bean Chip

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Bean V1.0

 Dedicated chip for the high-occupancy environment

Specs

- 32 channel
- 2820 Buffers
- 10 bit ADC/ channel
- Fast analog adding
- Successful Test phase just finished





Gaining momentum

Signatories per day (Acc) 2,400 World Europe Asia North America 1,800 South America Oceania Africa 1,200 600 0 Jan 2013 Feb 2013 Mar 2013 Apr 2013

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Signatories